mail

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





Intel[®] Enpirion[®] Power Solutions EM2030L01QI 30A PowerSoC

Step-Down DC-DC Switching Converter with Integrated Inductor

Description

The EM2030 is a fully integrated 30A PowerSoC synchronous buck converter. It features an advanced controller, gate drivers, synchronous MOSFET switches, and a high performance inductor. Only input and output filter capacitors and a few small signal components are required for a complete solution..

Differential remote sensing and $\pm 0.5\%$ set-point accuracy provide precise regulation over line, load and temperature variation. Very low ripple further reduces accuracy uncertainty to provide best in class static regulation for today's FPGAs, ASICs, processors, and DDR memory devices.

The EM2030 features high conversion efficiency and superior thermal performance to minimize thermal de-rating limitations, which is key to product reliability and longevity.

Features

- Integrated inductor, FETs, and controller
- Wide 4.5V to 16V V_{IN} range
- 0.5V to 1.325V_{OUT} range
- 30A continuous current with no thermal de-rating
- High efficiency in 11mm x 17mm x 6.76mm QFN package

 \circ 93% efficiency at V_{IN} = 5V, V_{OUT} = 1.325V \circ 90% efficiency at V_{IN} = 12V, V_{OUT} = 1.2V

- Optimized total solution size of only 365 mm²
- Tracking pin for complex sequencing
- Meets all high performance FPGA requirements

 0.5% set-point over line, load, and temperature
 Output ripple as low as 10 mV peak-peak
 Differential remote sensing
 Monotonic startup into pre-bias output
- RoHS compliant, MSL level 3, 260°C reflow

Applications

- High performance FPGA supply rails
- ASIC and processor supply rails
- High density double data rate (DDR) memory VDDQ rails

Ordering Information

	Table 1						
Part Number	Supported Vout Range	Package Markings	T _{AMBIENT} Rating (°C)	Package Description			
EM2030L01QI	0.5V to 1.325V	M2030L	-40 to +85	17 mm x 11 mm x 6.76 mm QFN100 provided in 112 units per tray			

Packing and Marking Information: www.altera.com/support/reliability/packing/rel-packing-and-marking.html

Pin Assignments

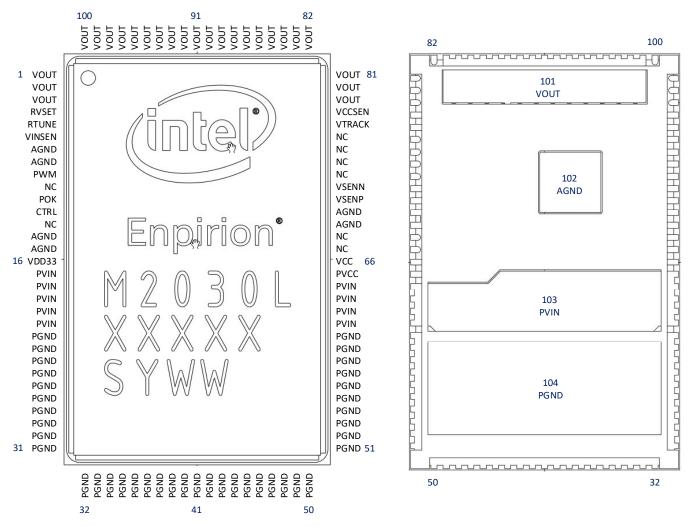


Figure 1: Pin Out Diagram

Pin Description

Table 2

PIN	NAME	I/O	FUNCTION
1,2,3, 79-101	VOUT	Regulated Output	Regulated output voltage. Decouple to PGND with appropriate filter capacitors
4	RVSET	1/0	A resistor from RVSET to AGND; and can be used to program the V_{OUT} set-point. Using 1% tolerance or better resistor. See Table 8 for more information.
5	RTUNE	1/0	A resistor from RTUNE to AGND; and can be used to tune the transient compensator for the amount of output capacitance. Using 1% tolerance or better resistor. See Table 9 for more information.
6	VINSEN	Input	Single-ended input voltage sense (relative to AGND).
7, 8, 14, 15, 69, 70, 102	AGND	Ground	Analog ground. Connect to system ground plane. Refer to layout section for more details on grounding.
9	PWM	PWM	PWM signal test pin.
10, 13, 67,68, 73-76	NC	NC	No connect. Do not connect to any signal, supply, or ground.
11	РОК	Input	Power OK signal. Open Drain Output
12	CTRL	Input	A high on the CTRL Pin will result in the Vout rising. CTRL should never be left floating
16	VDD33	Output	3.3V output of the internal LDO. May be used as pull-up supply CTRL pin.
17-21, 61-64, 103	PVIN	Input Supply	Input supply for MOSFET switches. Decouple to PGND with appropriate filter capacitors. Refer to Recommended Application Circuit section for more details.
22-60, 104	PGND	Ground	Power ground. Ground for MOSFET switches.
65	PVCC	Input Supply	5.0V supply voltage for driver circuitry. Decouple to GND using a 2.2µF MLCC high quality ceramic capacitor.
66	VCC	Input Supply	5.0V supply voltage for analog circuitry.
71	VSENP	Input	Differential output voltage sense input (positive).
72	VSENN	Input	Differential output voltage sense input (negative).
77	VTRACK	Input	Voltage tracking reference input. Vout will track applied signal. If not used, it cannot be left floating but should be connected to VDD33 using a $10k\Omega$ resistor.
78	VCCSEN	Input	Single-ended VCC voltage sense (relative to AGND)

Absolute Maximum Ratings

CAUTION: Absolute Maximum ratings are stress ratings only. Functional operation beyond the recommended operating conditions is not implied. Stress beyond the absolute maximum ratings may impair device life. Exposure to absolute maximum rated conditions for extended periods may affect device reliability. Voltage measurements are referenced to AGND.

Absolute Maximum Pin Ratings

	Tuble 5			
PARAMETER	SYMBOL	MIN	MAX	UNITS
Supply voltage PVIN	PVIN	-0.3	18	V
Supply voltage VCC & PVCC	VCC	-0.3	5.5	V
VCC ramp time	VCC		20	ms
VDD33	VDD33	-0.3	3.6	V
Power ground	PGND	-0.3	0.3	V
I/O pins	VINSEN, VCCSEN, RVSET, RTUNE, VTRACK	-0.3	2.0	V
I/O pin	CTRL	-0.3	3.6	V
I/O pin	РОК	-0.3	5.5	V
Voltage feedback	VSENP, VSENN	-0.3	2.0	V
PWM pin	PWM	-0.3	5.5	V
Output voltage pins	VOUT	-0.3	3.8	V
DC current on VOUT	VOUT		35	А

Table 3

Absolute Maximum Thermal Ratings

PARAMETER	CONDITION	MIN	MAX	UNITS
Operating junction temperature			+125	°C
Storage temperature range		-65	+150	°C
Reflow peak body temperature	(10 Sec) MSL3		+260	°C

Absolute Maximum ESD Ratings

PARAMETER	CONDITION	MIN	MAX	UNITS
HBD	All pins; Except VINSEN 1000 V Max	2000		V
CDM; all pins		500		V

Recommended Operating Conditions

Table 4

PARAMETER	PINS	MIN	MAX	UNITS
PVIN supply voltage range	PVIN	4.5	16	V
Supply voltage V _{CC} & PV _{CC}	VCC, PVCC	4.75	5.25	V
Continuous load current	V _{OUT}		30	А

Thermal Characteristics

Table 5

PARAMETER	PINS	TYPICAL	UNITS
Thermal shutdown	T _{SD}	120	°C
Thermal shutdown Hysteresis	T _{SDH}	18	°C
Thermal resistance: junction to ambient (0 LFM) (Note 1)	θ _{JA}	8	°C/W
Thermal resistance: junction to case bottom (0 LFM)	θJC	1.5	°C/W

Note 1: Based on 2 oz. external copper layers and proper thermal design in line with EIJ/JEDEC JESD51 standards for high thermal conductivity boards. No top side cooling required.

Electrical Characteristics

 PV_{IN} = 12V and V_{CC} = 5.0V. The minimum and maximum values are over the operating ambient temperature range (-40°C to 85°C) unless otherwise noted. Typical values are at T_A = 25°C.

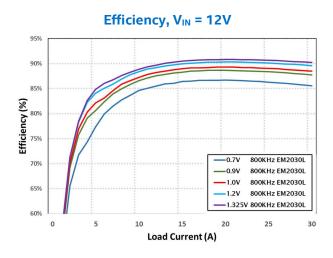
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
		SUPPLY CHARACTERISTICS				
PVIN supply voltage range	PVIN		4.5		16	V
PVIN supply		Device switching; no load; f _{sw} = 800 kHz; V _{OUT} = 1.0V		40		mA
quiescent current		Device not switching		1		1
VCC supply voltage range	VCC		4.75	5.0	5.25	V
VCC UVLO rising				4.4		V
VCC UVLO falling				4.2		V
		Normal operation; no load; f _{sw} = 800 kHz		80		mA
PVCC & VCC supply current		Idle; communication and telemetry only; no switching		30		mA
		Disabled ($V_{cc} \le 2.8V$)		900		μΑ
	INTE	RNALLY GENERATED SUPPLY V	OLTAGE	1	I	-1
VDD33 voltage range	VDD33		3.0	3.3	3.6	
VDD33 output current					2	mA
		Open Drain PIN (POK)				
Low voltage			0		0.8	V
Input leakage current					±1	μA
Output current - sink					2.0	mA
		I/O PIN (CTRL)				
Input high voltage			2.0		3.6	V
Input low voltage			-0.3		0.8	V
CTRL response delay (stop)				150		μs
CTRL response delay (start)				250		μs
		I/O PINS (VINSEN, VCCSEN)			•	
Input voltage			0		1.4	V
		I/O PIN PWM				

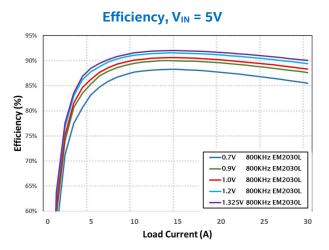
Table 6

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
PWM output voltage - high			2.4			V
PWM output voltage - low					0.4	v
PWM tristate leakage					±1	μA
PWM pulse width			30			ns
Resolution				163		ps
Switching frequency – EM2030N	f _{sw}	With internal oscillator		800		kHz
		I/O PIN VTRACK				
VTRACK ramp rate					2.0	V/ms
VTRACK range			0		1.4	V
VTRACK offset voltage				±100		mV
0	UTPUT VOL	TAGE SENSE, REPORTING, AND	MANAGE	MENT	•	•
Output voltage adjustment range			0.5		1.325	v
Output voltage set-		0°C < T _A < 85°C	-0.5		+0.5	%
point accuracy		-40°C < T _A < 85°C	-1		+1	%
Line regulation				0.007		mV/V
Load regulation				0.07		mV/A
Output voltage startup delay		From V _{cc} valid, to start of output voltage ramp		5		ms
Rise Time		VTRACK not used (tied high)		0.18		V/ms
Fall Time		VTRACK not used (tied high)		0.18		V/ms
	FAULT	MANAGEMENT PROTECTION FE	EATURES			
PV _{IN} UV threshold				4		V
PVIN OV threshold				16		V
V_{OUT} OV threshold		Percentage of output voltage		120		%
V_{OUT} UV threshold		Percentage of output voltage		85		%
I _{OUT} OCP		With 45A OCP setting	40		50	A
OTP threshold				120		°C
OTP hysteresis				102		°C
POK threshold		On level		95		%
POK threshold		Off level		90		%

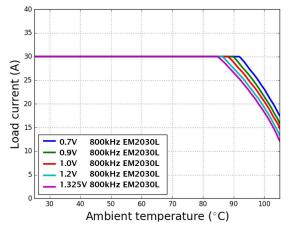
Typical Performance Characteristics

All the performance curves are measured with EM2030 evaluation board at 25°C ambient temperature unless otherwise noted. The output capacitors configuration for the evaluation board is 2 x 470 μ F (3 m Ω ESR) + 4 x 100 μ F (Ceramic) + 4 x 47 μ F (Ceramic)

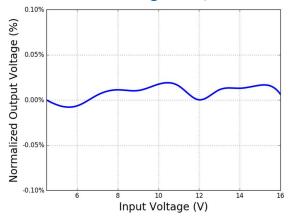


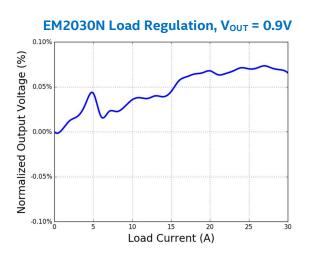


EM2030N Thermal Derating, No Airflow

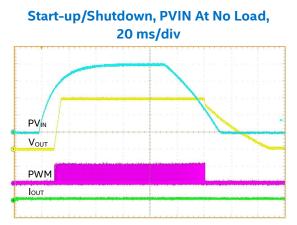


EM2030N Line Regulation, Vout = 0.9V



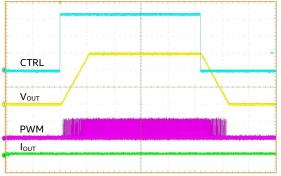


Typical Performance Characteristics (Continued)



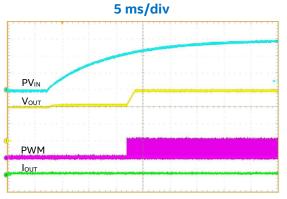
 PV_{IN} and PWM: 3 V/div, V_{OUT} : 300 mV/div, I_{OUT} : 10 A/div



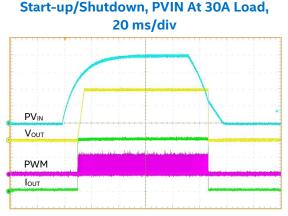


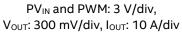
CTRL: 1 V/div, PWM: 3 V/div, V_{OUT}: 300 mV/div, I_{OUT}: 10 A/div

Start-up Into 0.6V Pre-Bias With PVIN,

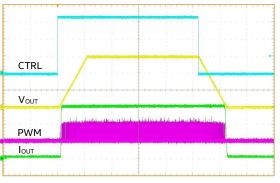


PV_{IN}: 3 V/div, PWM: 3 V/div, V_{OUT}: 300 mV/div, I_{OUT}: 10 A/div



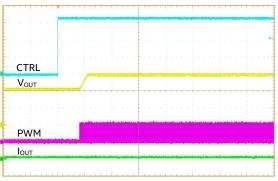


Start-up/Shutdown, CTRL At 30A Load, 5 ms/div



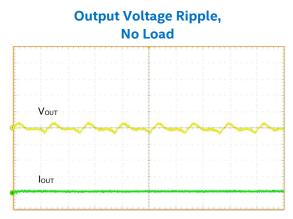
CTRL: 1 V/div, PWM: 3 V/div, V_{OUT}: 300 mV/div, I_{OUT}: 10 A/div

Start-up Into 0.6V Pre-Bias With CTRL, 5 ms/div



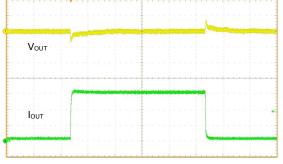
CTRL: 1 V/div, PWM: 3 V/div, V_{OUT}: 300 mV/div, I_{OUT}: 10 A/div

Typical Performance Characteristics (Continued)



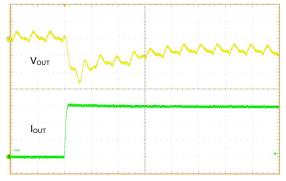
 $V_{\text{IN}} = 12V, V_{\text{OUT}} = 0.9V$ 1 µs/div, V_{OUT}: 10 mV/div, 20 MHz bandwidth



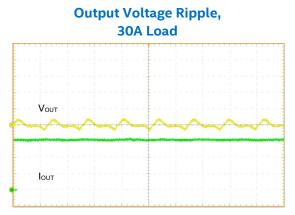


 V_{IN} = 12V, V_{OUT} = 0.9V, 100µs/div V_{OUT}: 30 mV/div, I_{OUT}: 5 A/div, 15 A/µs

Output Voltage Transient Response, Load Step From 0A To 15A

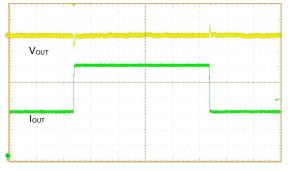


$$\label{eq:VIN} \begin{split} V_{\text{IN}} &= 12 V, V_{\text{OUT}} = 0.9 V, 2 \mu \text{s/div} \\ V_{\text{OUT}} &: 10 \text{ mV/div}, \text{I}_{\text{OUT}} &: 5 \text{ A/div}, 100 \text{ A/} \mu \text{s} \end{split}$$



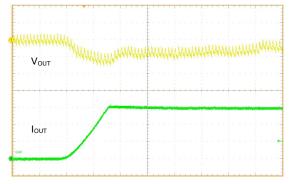
 $V_{\text{IN}} = 12V, V_{\text{OUT}} = 0.9V$ 1 µs/div, V_{OUT} : 10 mV/div, 20 MHz bandwidth

Output Voltage Transient Response, Load Step From 15A To 30A



 V_{IN} = 12V, V_{OUT} = 0.9V, 100µs/div V_{OUT}: 30 mV/div, I_{OUT}: 5 A/div, 15 A/µs

Output Voltage Transient Response, Load Step From 0A To 15A



$$\label{eq:VIN} \begin{split} V_{\text{IN}} &= 12V, V_{\text{OUT}} = 0.9V, 10\mu s/div\\ V_{\text{OUT}} &: 10 \text{ mV/div}, I_{\text{OUT}} &: 5 \text{ A/div}, 1 \text{ A/}\mu s \end{split}$$

Functional Block Diagram

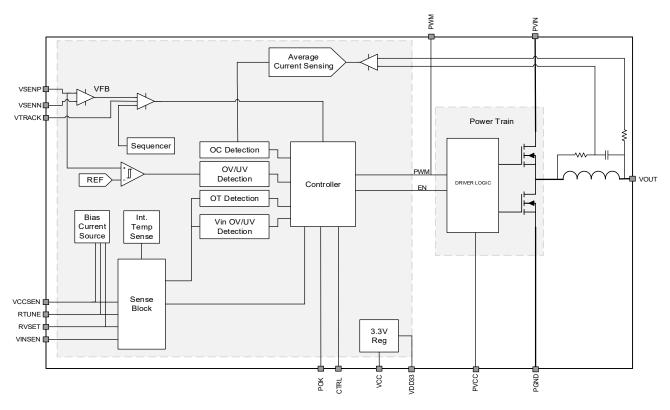


Figure 2: Functional Block Diagram

Functional Description

FUNCTIONAL DESCRIPTION:

The EM2030 is a single output PowerSoC synchronous step-down converter capable of supplying up to 30A of continuous output current. The PowerSoC includes integrated power MOSFETs, a high-performance inductor and a controller.

The EM2030 requires only two resistors to set the output voltage and set the compensation. This easy-to-use set-up allows the user to tune the EM2030 to meet the most demanding accuracy and load transient requirements. The device switches at 800KHz, and is optimized for both efficiency and transient performance and uses a voltage-mode controller.

The EM2030 controller features two PID compensators for steady-state operation and fast transient operation. Fast, reliable switching between the different compensation modes ensures good transient performance and quiet steady state performance. The EM2030 has been designed with a range of default compensation coefficients which lets the user select the best compensation for the best transient response and stability for the output capacitance of the system.

The EM2030 offers a complete suite of fault warnings and protections. Input and output Under Voltage Lock-Out (UVLO) and Over Voltage Lock-Out (OVLO) conditions are continuously monitored along with fast Over-

Current Protection (OCP). Over Temperature Protection (OTP) is accomplished by direct monitoring of the device's internal temperature.

POWER ON RESET

The EM2030 employs an internal power-on-reset (POR) circuit to ensure proper start-up and shut down with a changing supply voltage. Once the VCC supply voltage increases above the POR threshold voltage, the EM2030 begins the internal start-up process. Upon its completion, the device is ready for operation.

Two separate input voltage supplies are necessary to operate, PVIN (4.5V to 16V) and V_{CC} (4.75V to 5.25V). Both of these voltage rails must be monitored for proper power-up and to protect the power MOSFETs under various input power fault conditions. A voltage divider on each input voltage supply connected to VINSEN for the power rail (PVIN) and VCCSEN for the supply rail (VC) is used for I monitoring of both rails.

As illustrated in Figure 3, the values of resistors R1, R2, R3 and R4 are chosen so the internal monitoring circuitry is within the appropriate ranges. It is mandatory that the listed resistors values are used to ensure proper operation with the EM2030. The resistors used must be R1=11 k Ω , R2=1 k Ω , R3=10 k Ω and R4=3.3 k Ω , using 1% tolerance or better resistors.

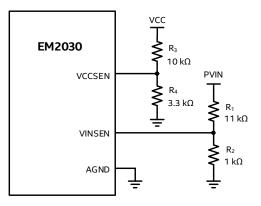


Figure 3: VINSEN And VCCSEN Input Resistor Dividers

The EM2030 also uses the PVIN monitor for input voltage feed-forward, which eliminates variations in the output voltage due to sudden changes in the input voltage supply. It does this by immediately changing the duty cycle to compensate for the input supply variation by normalizing the DC gain of the loop.

SETTING THE OUTPUT VOLTAGE

Differential remote sensing provides for precise regulation at the point of load. One of thirty output voltages may be selected, based on a resistor connected to the RVSET pin. At power-up, an internal current source biases the resistor and the voltage is measured to make the Vout selection. Use the RVSET tables (Table 8) for the details of V_{OUT} selection and RVSET values.

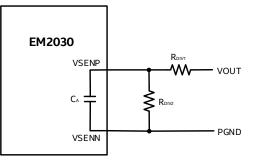


Figure 4: Output Voltage Sense Circuitry

The EM2030 supports direct output voltage feedback connection over the entire V_{OUT} range. The resistor RDVIV2 may be used to adjust VOUT slightly or to get a VOUT value not supported by RVSET. Resistors with tight tolerances are recommended to maintain output voltage accuracy.

The resistors in the feedback path also form a low-pass filter with the internal capacitor, C_A, for removing high-frequency disturbances from the sense signals. Place these components as close as possible to the EM2030 for best filtering performance.

Table 7: Output Voltage Feedback Component

Module	Vout	R _{DIV1}	R _{DIV2}
EM2030L01	$0.5V \le V_{OUT} \le 1.325V$	2 kΩ	Open

	-	
RVSET Resistor	V _{OUT}	External Resistor Divider
0kΩ	Reserved	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
0.392kΩ	Reserved	R_{1DIV} = 2k Ω , R_{2DIV} = open
0.576kΩ	0.5V	R_{1DIV} = 2k Ω , R_{2DIV} = open
0.787kΩ	0.72V	R_{1DIV} = 2k Ω , R_{2DIV} = open
1.000kΩ	1.325V	R_{1DIV} = 2k Ω , R_{2DIV} = open
1.240kΩ	1.3V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
1.500kΩ	1.275V	R_{1DIV} = 2k Ω , R_{2DIV} = open
1.780kΩ	1.25V	R_{1DIV} = 2k Ω , R_{2DIV} = open
2.100kΩ	1.225V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
2.430kΩ	1.2V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
2.800kΩ	1.175V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
3.240kΩ	1.15V	R_{1DIV} = 2k Ω , R_{2DIV} = open
3.740kΩ	1.12V	R_{1DIV} = 2k Ω , R_{2DIV} = open
4.220kΩ	1.1V	R_{1DIV} = 2k Ω , R_{2DIV} = open
4.750kΩ	1.075V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
5.360kΩ	1.05V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
6.040kΩ	1.03V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
6.810kΩ	1.0V	R_{1DIV} = 2k Ω , R_{2DIV} = open
7.680kΩ	0.975V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
8.660kΩ	0.95V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
9.530kΩ	0.925V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
10.500kΩ	0.9V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
11.800kΩ	0.875V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
13.000kΩ	0.85V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
14.300kΩ	0.825V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
15.800kΩ	0.8V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
17.400kΩ	0.775V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
19.100kΩ	0.75V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
21.000kΩ	0.725V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$
23.200kΩ	0.7V	$R_{1DIV} = 2k\Omega, R_{2DIV} = open$

Table 8: Supported Voltage Values For EM2030L01 Output Voltage

ENABLE and OUTPUT START-UP BEHAVIOR

The control pin (CTRL) provides a means to enable normal operation or to shut down the device. When the CTRL pin asserted (high) the device will undergo a normal soft-start. A logic low on this pin will power the device down in a controlled manner. Dedicated pre-biased start-up logic ensures proper start-up of the power converter when the output capacitors are pre-charged to a non-zero output voltage. Closed-loop stability is ensured during this period.

The typical power sequencing, including ramp up/down and delays is shown in Figure 5.

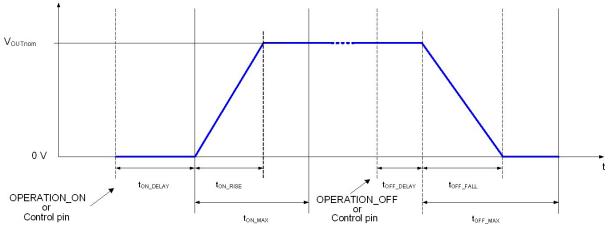


Figure 5: Power Sequencing

POWER OK

The EM2030 has a Power OK (POK) indicator at its output pin, which is Open Drain and therefore requires a pull-up resistor. The Pull-Up resistor may be connected to the VDD33 pin but it is not recommended to use the 5VCC supply. When de-asserted, POK indicates that the output voltage is below a certain threshold value. The POK on threshold is set to 95% of the programmed output voltage. When asserted, POK indicates that the output is in regulation, and no major faults are present. POK de-asserts (90%) during any serious fault condition where power conversion stops and re-asserts when the output voltage recovers.

In a noisy application, it is strongly recommended that a 100nf decoupling capacitor be placed between the POK pin and GND to act as a filter to unwanted external noise .

COMPENSATING THE CONTROL LOOP

To improve the transient performance for a typical point-of-load design, it is common to add output capacitance to the converter. This moves the output LC resonant frequency lower as capacitance increases which results in lower bandwidth, lower phase margin, and longer settling times unless the control loop is compensated for added capacitance.

However, with EM2030 the user does not need to be concerned with, or even understand, the details of control loop compensation techniques. RTUNE allows users to select from a number of PID control loop settings (known as compensators) through the use of pin-strapping. A single resistor from the RTUNE pin to AGND informs the EM2030 of the compensator selection.

The selection of the compensator is driven first by the type of output capacitors used, as the ESL and ESR of different capacitor types demands different PID coefficients to optimize transient deviation and recovery characteristics. An all ceramic output capacitor design requires a different compensator than a design with a

combination of ceramic and polymer capacitors, i.e. POSCAP. Table 10 shows several output capacitor part number recommendations.

The EM2030 supports three different compensators can then be subdivided into groups of six each whereby the initial capacitance value in the appropriate compensator can be scaled upwards by multiplication factor M to match the additional capacitance.

Compensator Description	Соит	RTUNE Resistor	Multiplication factor (M)	Typical Deviation With 15A Load Step
	Base	0kΩ	1	± 5%
Polymer Aluminum (SP-CAP) and Ceramic MLCC Output Capacitors Base capacitance = 1 x 470µF (Polymer) + 2 x 100µF (Ceramic) + 2 x 47µF (Ceramic)	2 x Base	0.392kΩ	2	± 3%
	3 x Base	0.576kΩ	3	
	4 x Base	0.787kΩ	4	± 1.5%
	5 x Base	1.000kΩ	5	
	6 x Base	1.240kΩ	6	
	Base	1.500kΩ	1	± 5%
	1.5 x Base	1.780kΩ	1.5	
All MLCC Ceramic Output Capacitors	2 x Base	2.100kΩ	2	± 3%
Base capacitance = 8 x 100µF	3 x Base	2.430kΩ	3	
	4 x Base	2.800kΩ	4	
	4.5 x Base	3.240kΩ	4.5	± 1.5%
	Base	3.740kΩ	1	± 5%
POSCAP and Ceramic MLCC	1.5 x Base	4.220kΩ	1.5	
Output Capacitors	2 x Base	4.750kΩ	2	± 3%
Base capacitance = 4 x 330 μF (POSCAP) + 2 x 100 μF	2.5 x Base	5.360kΩ	2.5	
(Ceramic)	3 x Base	6.040kΩ	3	± 1.5%
	3.5 x Base	6.810kΩ	3.5	

Table 9: RTUNE table for EM2030L01

	and the second			
Description	Manufacturer P/N			
$470\mu F$, 2.5V, ESR $3m\Omega$ SP-CAP	Panasonic	EEFGX0E471R		
330μ F, 6.3 V, ESR $9 \text{ m}\Omega \text{ POSCAP}$	Panasonic 6TPF330M9L			
220μ F, 6.3V, ESR 5 m Ω POSCAP	Panasonic	6TPF220M5L		
330μ F, 2.5V, ESR 9 m Ω POSCAP	Kemet T520B337M2R5ATE009			
100µF, 6.3V, X5R, 1206 Ceramic	Kemet C1206C107M9PACTU			
47µF, 6.3V, X5R 1206 Ceramic	Murata	GRM31CR60J476ME19L		

Table 10: Recommended Output Capacitors

OUTPUT CAPACITOR RECOMMENDATION

EM2030 is designed for fast transient response and low output ripple noise. The output capacitors should be low ESR polymer, tantalum or ceramic capacitor. Table 9 shows different output capacitor combinations to optimize the load transient deviation performance. With the Rtune feature, the user can simply scale up the total output capacitance to meet further signet transient requirement.

Please consult the documentation for your particular FPGA, ASIC, processor, or memory block for the transient and the bulk decoupling capacitor requirements.

INPUT CAPACITOR RECOMMENDATION

The EM2030 input should be decoupled with at least three 22μ F 1206 case size and one 10μ F 0805 case size MLCC ceramic capacitors or four 22μ F MLCC 1206 case size ceramic capacitors. More bulk capacitor may be needed only if there are long inductive traces at the input source or there is not enough source capacitance.

These input decoupling ceramic capacitors can be mounted on the PCB back-side to reduce the solution size. These input filter capacitors should have the appropriate voltage rating for the input voltage on PVIN, and use a X5R, X7R, or equivalent dielectric rating. Y5V or equivalent dielectric formulations must not be used as these lose too much capacitance with frequency, temperature and bias voltage.

The PVCC pin provides power to the gate drive of the internal high/low side power MOSFETs. The VCC pin provides power to the internal I controller. These two power inputs share the same supply voltage (5V nominal), and should be bypassed with a single 2.2µF MLCC capacitor. To avoid switching noise injection from PVCC to VCC, it is recommended a ferrite bead is inserted between PVCC and VCC pins as shown Figure 13.

PROTECTION FEATURES

The EM2030 has a complete suite of programmable fault protections. Input and output Under Voltage Lock-Out (UVLO) and Over Voltage Lock-Out (OVLO) conditions are continuously monitored along with the output current to provide fast Over-Current Protection (OCP) response.

To prevent damage to the load, the EM2030 also utilizes an output over-voltage protection circuit. The voltage at VSENP is continuously compared with a RVSET OVP threshold using a high-speed analog comparator. If the voltage exceeds the OVP threshold, a fault response is generated and the PWM output is turned off.

Over Temperature Protection (OTP) is based on direct monitoring of the device's internal temperature. If the temperature exceeds the OTP threshold, the device will enter a soft-stop mode slowly ramping the output voltage down until the temperature falls below the default recovery temperature.

The default fault response is for the output to latch off for most fault conditions. The CTRL pin may be cycled to clear the latch. Table 11 summarizes the default settings that have been implemented in the device.

Signal	Fault Level	Response Type	VOUT
Output Over-Voltage	Fault	High-impedance	Latched Off
Output Under-Voltage	Fault	High-impedance	Latched Off
Input Over-Voltage	Fault	High-impedance	Latched Off
Input Under-Voltage	Fault	High-impedance	Retry if Fault removed
Over-Current	Fault	High-impedance	Latched Off
Over-Temperature	Fault	Soft Off	Retry if Fault removed

Table 11: Fault Overview

The EM2030 monitors various signals during operation in order to detect fault conditions. Measured and filtered signals are compared to a fault threshold which when triggered generates a response as given in table Table 11

The EM2030 fault response depends on the fault type detected.

The EM2030 responds to an over temperature event by ramping down V_{OUT} in a controlled manner at a slew rate of approx. 0.18v/ms. For all other faults the EM2030 will respond by immediately turning off both the top-side MOSFET and low-side MOSFET.

In the event of a Temperature Fault or a Low PVIN Fault the module will restart Vout automatically without user intervention once the fault is deemed to have been removed. For all other faults the module will remain off until the user either toggles the control pin or recycled the supply whereupon if the fault is removed the VOUT will restart.

PRE-BIASED START-UP

In systems with complex power architectures, there may be leakage paths from one supply domain which charge capacitors in another supply domain leading to a pre-biased condition on one or more power supplies. This condition is not ideal and can be avoided through careful design, but is generally not harmful. Attempting to discharge the pre-bias is not advised as it may force high current though the leakage path. The EM2030 include a feature to allow it to be enabled into pre-biased output capacitors without discharging them

If the output capacitors are pre-biased when the EM2030 is enabled, start-up logic in the EM2030 ensures that the output does not pull down the pre-biased voltage. Closed-loop stability is ensured during the entire start-up sequence under all pre-bias conditions.

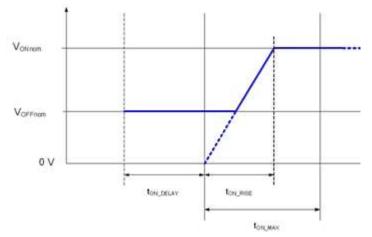


Figure 6: Power Sequencing with Non-Zero Off Voltage

VOLTAGE TRACKING

The EM2030 can control the output voltage based on the external voltage applied to the VTRACK pin, thus allowing sequencing of the output voltage from an external source. Pre-bias situations are also supported. The VTRACK pin voltage is a single-ended input referenced to analog ground.

If VTRACK is not intended to be used, the VTRACK pin must be tied high. (It cannot be tied low left floating).

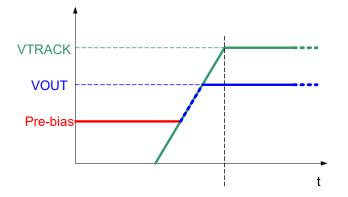


Figure 7: Power Sequencing Using VTRACK With Bias Voltage On VOUT

The set point voltage for the EM2030 is defined by the lower value of the V_{OUT} setting or an external voltage applied to the VTRACK pin. If the VTRACK voltage rises above the V_{OUT} set point voltage, then the final output voltage will be limited by the V_{OUT} setting. If the VTRACK pin is tied low or floating, then the output will never start as the VTRACK pin input is always the lower value and will always be in control. Conversely, if VTRACK is tied high, the output will start but will follow the V_{OUT} set point, not the VTRACK pin.

If tracking is used for sequencing, it is recommended that the VTRACK signal is kept greater than the V_{OUT} voltage. This ensures that the internal V_{OUT} set point is used as the final steady-state output voltage and accuracy is not a function of the externally applied VTARCK voltage.

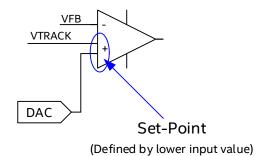
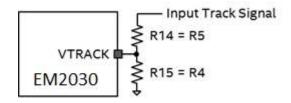


Figure 8: VTRACK Circuitry

The following figures demonstrate ratio-metric and simultaneous sequencing of the output voltage, which can be accomplished by applying an appropriate external voltage on the VTRACK pin. When using the VTRACK feature, the sequencing will be ratio-metric as shown in Figure 11 if an external resistor network is used at the VTRACK pin as shown Figure 9. If no external resistors are used, the output sequence is simultaneous as shown in Figure 12.

In the event that a feedback divider is not required, but the tracking voltage applied to VTRACK is greater than 1.4V, then a $2k\Omega$ resistor is required in series with the VTRACK pin to minimize leakage current as shown in Figure 10.

In applications where a voltage divider is required on the output voltage, a voltage divider consisting of the same values is also required for the VTRACK pin.





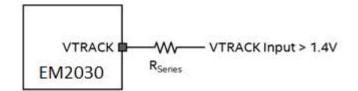
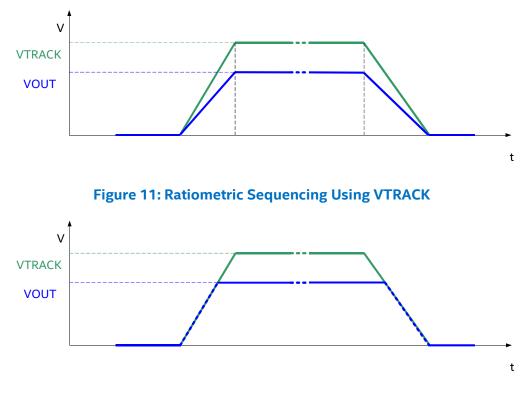


Figure 10: VTRACK Sense Circuitry (Input > 1.4V)





TEMPERATURE AND OUTPUT CURRENT MEASUREMENT

The EM2030 temperature sense block provides the device with precision temperature information over a wide range of temperatures (-40°C to +150°C). The temperature sense block measures the controller temperature, which will be slightly lower than the powertrain junction temperature.

The EM2030 monitors output current by real-time, temperature compensated DCR current sensing across the inductor. This real-time current waveform is then filtered and averaged for accurate fault warning and management.

Factory calibration has been performed for every EM2030 device to improve measurement accuracy over the full output current range. This allows the EM2030 to correct for DCR manufacturing variations.

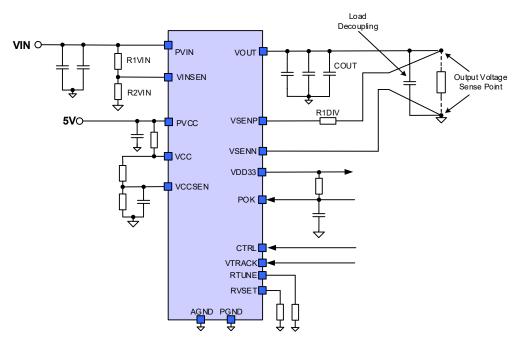


Figure 13: Recommended Application Circuit

Layout Recommendations

Recommendation 1: It is highly recommended to use separate nets for AGND and PGND and connecting them through a 0Ω resistor or a short. This method helps with ground management and prevents the noise from the Power Ground disturbing the more sensitive Analog ("Signal") Ground.

Recommendation 2: It is good practice to minimize the PGND loop. Whenever possible the input and output loops should close to the same point, which is the ground of the EM2030 module. Module decoupling ceramic capacitors are to be placed as close as possible to the module in order to contain the switching noise in the smallest possible loops and to improve PVIN decoupling by minimizing the series parasitic inductance of the PVIN traces. For achieving this goal, it helps to place decoupling capacitors on the same side as the module since VIAs are generally more inductive, thus reducing the effectiveness of the decoupling. Of course, bulk and load high frequency decoupling should be placed closer to the load.

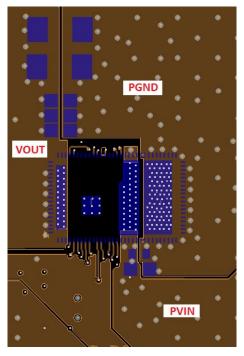


Figure 14: Top Layer Layout With Critical Components Only

Recommendation 3: It is good practice to place the other small components needed by the EM2030 on the opposite side of the board, in order to avoid cutting the power planes on the module side. Since the EM2030 heat is evacuated mostly through the PCB, this will also help with heat dissipation; wide copper planes under the module can also help with cooling. The PVIN copper plane should not be neglected as it helps spread the heat from the high side FET.

Recommendation 4: It is recommended that at least below the EM2030 module, the next layers to the surface (2 and n-1) be solid ground planes, which provides shielding and lower the ground impedance at the module level. AGND should be also routed as a copper plane, in order to reduce the ground impedance and reduce noise injection.

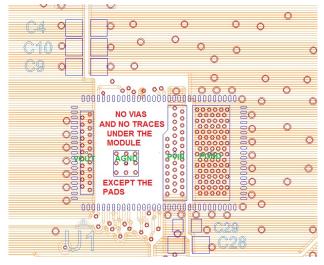


Figure 15: VIAs in The Power Pads

Recommendation 5: In order to better spread the current and the heat through the inner layers, arrays of VIAs should be placed in the power pads. 10mils diameter is a good size for the plated in-pad VIAs. It is critical that through VIAs should not be placed by any means elsewhere under the module; the non-pad area around AGND is VIA keep out area.

Recommendation 6: All other signal and LDO decoupling capacitors should be placed as close as possible to the terminal they are decoupling, while the AGND connection should be done through VIAs to the AGND plane.

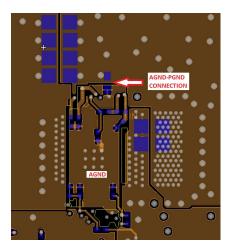


Figure 16: Backside Decoupling All Signal Decoupling Go To The Bottom AGND Plane And Get Connected To The EM2030 Module AGND Through The AGND In-PAD VIAs (Again, No Other VIAs Are Allowed In That Area)

Recommendation 7: Figure 20 also shows the 0Ω resistor that connects AGND to PGND. The recommended connecting point, as shown, is to a quiet PGND \rightarrow the output capacitors PGND.

Recommendation 8: Differential remote sense should be routed as much as possible as a differential pair, on an inner layer, preferably shielded by a ground plane.

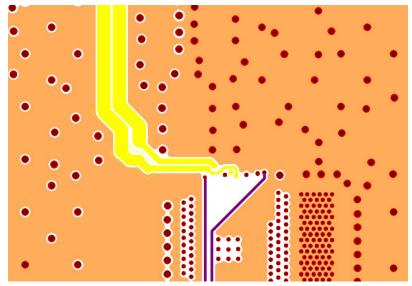


Figure 17: Remote Sense Routing On An Inner Layer (Highlighted, Yellow)

Recommendation 9: If the design allows it, stitching VIAs can be used on the power planes, close to the module in order to help with cooling. This is a thermal consideration and does not matter much for the electrical design.